

## **DESCRIPTION**

The *highly efficient* Model DCS*e*606 is the ideal solution for submicron double-sided cleaning of Photomasks, Wafers and Substrates. The *very reliable* and *cost effective* system utilizes *proven* assortment of cleaning technologies. The DCSe606 can be configured with several different cleaning options form High Pressure DI, Atomizing Mist Nozzle, Brushes, Megasonic Pies and Nozzles, and much more. The Rapid and Effective Drying technique combines Variable Spin Speeds optional Heated DI, Nitrogen Assist or Heat Lamp. The DCS*e*606 has a Microprocessor Controller allowing variable process parameters and retention of up to (10) ten process programs in memory.

## FEATURES:

- Up to Twenty (20) Inch Diameter Substrate Compatibility
- Main Spindle Assembly having Servo Motor.
- Adjustable Arm Speed and Travel Positions.
- Radially Exhausted Chamber for Maximum Laminar Flow.
- Stand-alone Polypropylene Cabinet.
- Microprocessor Control Capable of Retaining Ten (10) Programs in Memory
- Built in Safety Interlocks.
- Push Button Lid Open/Close.
- Touch Screen Graphic User Interface (GUI) with Ease of Programming & Security Lockouts and On-Screen Error Reporting.
- Maximum Capability of Two Arms.

## OPTIONS: Up to TWO Oscillating Arms

- Various sizes of vacuum and edge-grip chucks for Wafers, Photomasks, and other Substrates
- Adjustable Self Cleaning Brush Assembly
- N<sub>2</sub> Drying Assist with 0.02 µm Filtration
- Fixed or Oscillating Low Pressure Dispenses
- Surfactant or Photoresist Dispense Canisters
- Chamber Rinse and/or Chamber Exhaust Assembly
- 0.2 µm Filtration for Low Pressure Dispenses
- D.I. Water Heater and Dispenses
- Oscillating Megasonic DI Water Dispense Arm







41980 Christy Street, Fremont, CA 94538 TEL: (510) 440-3900 FAX: (510) 440-3920 www.ultrat.com